

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

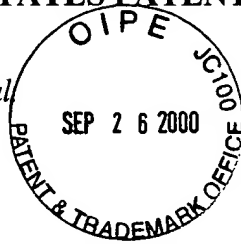
GAU: 2823  
5/FRT. (2)  
9/29/00  
JELVEL

In re the application of: Wilk *et al*

Serial No.: 09/176,422

Filed: 10/21/98

For: Low Temperature Method for Forming a Thin, Uniform Oxide



Docket:

TI-24742

Examiner:

N. Berezny

Art Unit:

2823

SEP 28 2000

TECH. NOLOGY CENTER 2800

**Petition For Extension of Time Under 37 C.F.R. § 1.136**

September 20, 2000

Assistant Commissioner For Patents  
Washington, D. C. 20231

MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231 on September 20, 2000.

David Denker Reg. No. 40,987

Dear Sir:

Applicants respectfully petition the Commissioner for a two month extension of the shortened statutory period for response in the above-identified application.

Please charge this and any other required fee—including additional extension of time fees—to the deposit account of Texas Instruments Incorporated, Account No. 20-0668. Any further necessary extension of time is hereby requested. **Two additional copies of this sheet are enclosed.**

Respectfully submitted,

David Denker  
Reg. No. 40,987

10/02/2000 TDAWKINS 00000001 200668 09176422

01 FC:116 380.00 CH  
02 FC:103 54.00 CH

Texas Instruments Incorporated  
P. O. Box 655474, MS 3999  
Dallas, Texas 75265  
(972) 917-4388  
Fax (972) 917-4418